## **AMENDMENTS TO THE CLAIMS**

This listing of claims will replace all prior versions and listings of claims in the application:

## **LISTING OF CLAIMS:**

- 1. (Original): A sensor comprising:
  - a dielectric block;
  - a thin film formed on a face of the dielectric block and in contact with a specimen;
  - a semiconductor laser unit as a light source which emits a light beam;
- a first optical system which injects the light beam into the dielectric block so that the light beam is incident on a boundary between the dielectric block and the thin film at a plurality of incident angles which are greater than a critical angle for total reflection; and
- a light detecting unit which detects a state of attenuated total reflection by measuring an intensity of the light beam totally reflected from the boundary;

wherein said semiconductor laser unit is driven with a driving current on which a high frequency component is superimposed.

- 2. (Original): A sensor according to claim 1, wherein said semiconductor laser unit comprises a stabilization unit for stabilizing an oscillation wavelength.
- 3. (Original): A sensor according to claim 2, wherein said stabilization unit comprises, a second optical system which feeds back to the semiconductor laser unit a portion of the

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light beam emitted from the semiconductor laser unit, and

a wavelength selection unit which selects a wavelength of the portion of the light beam.

4. (Original): A sensor according to claim 3, wherein the frequency of the high-frequency

component superimposed on said semiconductor laser is within the range of 200MHz-1000MHz.

5. (Original): A sensor comprising:

a dielectric block;

a metal film formed on a face of the dielectric block and in contact with a specimen;

a semiconductor laser unit as a light source which emits a light beam;

a first optical system which injects the light beam into the dielectric block so that the light

beam is incident on a boundary between the dielectric block and the metal film at a plurality of

incident angles which are greater than a critical angle for total reflection; and

a light detecting unit which detects a state of attenuated total reflection due to surface

plasmon resonance by measuring an intensity of the light beam totally reflected from the

boundary;

wherein said semiconductor laser unit is driven with a driving current on which a high

frequency component is superimposed.

6. (Original): A sensor according to claim 5, wherein said semiconductor laser unit

comprises a stabilization unit for stabilizing an oscillation wavelength.

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- 7. (Original): A sensor according to claim 6, wherein said stabilization unit comprises, a second optical system which feeds back to the semiconductor laser unit a portion of the
- light beam emitted from the semiconductor laser unit, and
  - a wavelength selection unit which selects a wavelength of the portion of the light beam.
- 8. (Original): A sensor according to claim 7, wherein the frequency of the high-frequency component superimposed on said semiconductor laser is within the range of 200MHz-1000MHz.
- 9. (Original): A sensor comprising:
  - a dielectric block;
  - a cladding layer formed on a face of the dielectric block;
  - an optical waveguide layer formed on the cladding layer and in contact with a specimen;
  - a semiconductor laser unit as a light source which emits a light beam;
- a first optical system which injects the light beam into the dielectric block so that the light beam is incident on a boundary between the dielectric block and the cladding layer at a plurality of incident angles which are greater than a critical angle for total reflection; and
- a light detecting unit which detects a state of attenuated total reflection due to excitation of a propagation mode in the optical waveguide layer, by measuring an intensity of the light beam totally reflected from the boundary;

wherein said semiconductor laser unit is driven with a driving current on which a high frequency component is superimposed.

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- 10. (Original): A sensor according to claim 9, wherein said semiconductor laser unit comprises a stabilization unit for stabilizing an oscillation wavelength.
- 11. (Original): A sensor according to claim 10, wherein said stabilization unit comprises, a second optical system which feeds back to the semiconductor laser unit a portion of the light beam emitted from the semiconductor laser unit, and a wavelength selection unit which selects a wavelength of the portion of the light beam.
- 12. (Original): A sensor according to claim 11, wherein the frequency of the high-frequency component superimposed on said semiconductor laser is within the range of 200MHz-1000MHz.
- 13. (New): A sensor according to claim 3, wherein said stabilization unit comprises a resonator disposed from an end of the semiconductor laser unit to a reflecting member.
- 14. (New): A sensor according to claim 13, wherein said resonator is an external resonator.
- 15. (New): A sensor according to claim 13, wherein said semiconductor laser unit is disposed at a fixed distance from the reflecting member.